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Devices in the S6E2C4 Series are highly integrated 32-bit microcontrollers with high performance and competitive cost. This series is based on the ARM Cortex-M4F processor with on-chip flash memory and SRAM. The series has peripherals such as motor control timers, A/D converters, and communications interfaces (CAN, UART, CSIO (SPI), I<sup>2</sup>C, LIN). The products that are described in this data sheet are placed into TYPE3-M4 product categories "FM4 Family Peripheral Manual Main Part (002-04856)."

## Features

### 32-bit ARM Cortex-M4F Core

- Processor version: r0p1
- Up to 200 MHz frequency operation
- FPU built-in
- Support DSP instructions
- Memory protection unit (MPU): improves the reliability of an embedded system
- Integrated nested vectored interrupt controller (NVIC): 1 NMI (non-maskable interrupt) and 128 peripheral interrupts and 16 priority levels
- 24-bit system timer (Sys Tick): system timer for OS task management

### On-chip Memories

#### ■ Flash memory

This series is based on two independent on-chip flash memories.

- Up to 2048 Kbytes
- Built-in flash accelerator system with 16 Kbytes trace buffer memory
- Read access to flash memory that can be achieved without wait-cycle up to an operating frequency of 72 MHz. Even at the operating frequency more than 72 MHz, an equivalent single cycle access to flash memory can be obtained by the flash accelerator system.
- Security function for code protection

#### ■ SRAM

This is composed of three independent SRAMs (SRAM0, SRAM1 and SRAM2). SRAM0 is connected to the I-code bus or D-code bus of Cortex-M4F core. SRAM1 and SRAM2 are connected to system bus of Cortex-M4F core.

- SRAM0: up to 192 Kbytes
- SRAM1: 32 Kbytes
- SRAM2: 32 Kbytes

### External Bus Interface

- Supports SRAM, NOR, NAND flash and SDRAM device
- Up to 9 chip selects CS0 to CS8 (CS8 is only for SDRAM)
- 8-/16-/32-bit data width
- Up to 25-bit address bus
- Maximum Access size: 256M byte
- Supports address/data multiplexing
- Supports external RDY function
- Supports scramble function
  - Possible to set the validity/invalidity of the scramble function for the external areas 0x6000\_0000 to 0xFFFF\_FFFF in 4 Mbytes units.
  - Possible to set two kinds of the scramble key
  - **Note:** It is necessary to use the Cypress provided software library to use the scramble function.

### CAN Interface (Max two Channels)

- Compatible with CAN specification 2.0A/B
- Maximum transfer rate: 1 Mbps
- Built-in 32-message buffer

### CAN-FD Interface (One Channel)

- Compatible with CAN Specification 2.0A/B
- Maximum transfer rate: 5 Mbps
- Message buffer for receiver: up to 192 messages
- Message buffer for transmitter: up to 32 messages
- CAN with flexible data rate (non-ISO CAN-FD)
- **Notes:**
  - CAN FD cannot communicate between non-ISO CAN FD and ISO CAN FD, because non-ISO CAN FD and ISO CAN FD are different frame format.
  - About the problem of "non-ISO CAN FD", see the White Paper from CiA(CAN in Automation).  
[http://www.can-newsletter.org/engineering/standardization/141222\\_can-fd-and-crc-issued\\_white-paper\\_bosch](http://www.can-newsletter.org/engineering/standardization/141222_can-fd-and-crc-issued_white-paper_bosch)

### Multi-function Serial Interface (Max 16 channels)

- Separate 64 byte receive and transmit FIFO buffers for channels 0 to 7.
- Operation mode is selectable for each channel from the following:
  - UART
  - CSIO (SPI)
  - LIN
  - I<sup>2</sup>C
- UART
  - Full-duplex double buffer
  - Selection with or without parity supported
  - Built-in dedicated baud rate generator
  - External clock available as a serial clock
  - Various error detect functions available (parity errors, framing errors, and overrun errors)
- CSIO (SPI)
  - Full-duplex double buffer
  - Built-in dedicated baud rate generator
  - Overrun error detect function available
  - Serial chip select function (ch 6 and ch 7 only)
  - Supports high-speed SPI (ch 4 and ch 6 only)
  - Data length 5 to 16-bit
- LIN
  - LIN protocol Rev.2.1 supported
  - Full-duplex double buffer
  - Master/slave mode supported
  - LIN break field generation (can change to 13- to 16-bit length)
  - LIN break delimiter generation (can change to 1- to 4-bit length)
  - Various error detect functions available (parity errors, framing errors, and overrun errors)
- I<sup>2</sup>C
  - Standard mode (Max 100 kbps)/Fast mode (Max 400 kbps) supported
  - Fast mode Plus (Fm+) (Max 1000 kbps, only for ch 3 = ch A and ch 7 = ch B) supported

### DMA Controller (Eight channels)

DMA controller has an independent bus, so the CPU and DMA controller can process simultaneously.

- Eight independently configured and operated channels
- Transfer can be started by software or request from the built-in peripherals
- Transfer address area: 32-bit (4 GB)
- Transfer mode: Block transfer/Burst transfer/Demand transfer
- Transfer data type: bytes/half-word/word
- Transfer block count: 1 to 16
- Number of transfers: 1 to 65536

### DSTC (Descriptor System data Transfer Controller; 256 Channels)

The DSTC can transfer data at high-speed without going via the CPU. The DSTC adopts the descriptor system and, following the specified contents of the descriptor that has already been constructed on the memory, can access directly the memory/peripheral device and perform the data-transfer operation.

It supports the software activation, the hardware activation, and the chain activation functions.

### A/D Converter (Max 32 channels)

- 12-bit A/D Converter
  - Successive approximation type
  - Built-in three units
  - Conversion time: 0.5 μs at 5 V
  - Priority conversion available (priority at two levels)
  - Scanning conversion mode
  - Built-in FIFO for conversion data storage (for SCAN conversion: 16 steps, for priority conversion: 4 steps)

### D/A Converter (Max 2 Channels)

- R-2R type
- 12-bit resolution

### Base Timer (Max 16 Channels)

Operation mode is selected from the following for each channel:

- 16-bit PWM timer
- 16-bit PPG timer
- 16-/32-bit reload timer
- 16-/32-bit PWC timer

### General Purpose I/O Port

This series can use its pins as general purpose I/O ports when they are not used for external bus or peripherals; moreover, the port relocate function is built in. It can set the I/O port to which the peripheral function can be allocated.

- Capable of pull-up control per pin
- Capable of reading pin level directly
- Built-in port-relocate function
- Up to 120 high-speed general-purpose I/O ports in 144 pin package
- Some pins 5V tolerant I/O.  
See 4. Pin Descriptions and 5. I/O Circuit Type for the corresponding pins.

### Multi-function Timer (Max three Units)

The multi-function timer is composed of the following blocks:

Minimum resolution: 5.00 ns

- 16-bit free-run timer × 3 ch/unit
- Input capture × 4 ch/unit
- Output compare × 6 ch/unit
- A/D activation compare × 6 ch/unit
- Waveform generator × 3 ch/unit
- 16-bit PPG timer × 3 ch/unit

The following functions can be used to achieve the motor control:

- PWM signal output function
- DC chopper waveform output function
- Dead time function
- Input capture function
- A/D convertor activate function
- DTIF (motor emergency stop) interrupt function

### Real-Time Clock (RTC)

The real-time clock can count year, month, day, hour, minute, second, or day of the week from 00 to 99.

- Interrupt function with specifying date and time (year/month/day/hour/minute) is available. This function is also available by specifying only year, month, day, hour, or minute.
- Timer interrupt function after set time or each set time.
- Capable of rewriting the time with continuing the time count.
- Leap year automatic count is available.
- 

### Quadrature Position/Revolution Counter (QPRC; Max four Channels)

The Quadrature Position/Revolution Counter (QPRC) is used to measure the position of the position encoder. It is also possible to use up/down counter.

- The detection edge of the three external event input pins AIN, BIN and ZIN is configurable.
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers

### Dual Timer (32/16-bit Down Counter)

The dual timer consists of two programmable 32/16-bit down counters.

Operation mode is selectable from the following for each channel:

- Free-running
- Periodic (= Reload)
- One shot

### Watch Counter

The watch counter is used for wake up from low-power consumption mode. It is possible to select the main clock, sub clock, built-in High-speed CR clock, or built-in low-speed CR clock as the clock source.

- Interval timer: up to 64 s (max) with a sub clock of 32.768 kHz

### External Interrupt Controller Unit

- External interrupt input pin: Max 32 pins
- Include one non-maskable interrupt (NMI)

### Watchdog Timer (2 Channels)

A watchdog timer can generate interrupts or a reset when a time-out value is reached.

This series consists of two different watchdogs: a "hardware" watchdog and a "software" watchdog.

The hardware watchdog timer is clocked by low-speed internal CR oscillator. The hardware watchdog is thus active in any power saving mode except RTC mode and Stop mode.

### Cyclic Redundancy Check (CRC) Accelerator

The CRC accelerator helps to verify data transmission or storage integrity.

CCITT CRC16 and IEEE-802.3 CRC32 are supported.

- CCITT CRC16 generator polynomial: 0x1021
- IEEE-802.3 CRC32 generator polynomial: 0x04C11DB7

## Programmable Cyclic Redundancy Check (PRGCRC) Accelerator

The CRC accelerator helps verify data transmission or storage integrity.

CCITT CRC16, IEEE-802.3 CRC32 and generating polynomial are supported.

- CCITT CRC16 generator polynomial: 0x1021
- IEEE-802.3 CRC32 generator polynomial: 0x04C11DB7
- Generating polynomial

## SD Card Interface

It is possible to use the SD card that conforms to the following standards.

- Part 1 Physical Layer Specification version 3.01
- Part E1 SDIO Specification version 3.00
- Part A2 SD Host Controller Standard Specification version 3.00
- 1-bit or 4-bit data bus

## I<sup>2</sup>S (Inter-IC Sound Bus) Interface (TX x 1 channel, RX x 1 channel)

- Supports three transfer protocols
  - I<sup>2</sup>S
  - Left justified
  - DSP mode
  - Separate clock generation block for flexible system integration options
- Master/slave mode selectable
- RX Only, TX Only or TX and RX simultaneous operation selectable
- Word length is programmable from 7-bits to 32 bits
- RX/TX FIFO integrated (RX: 66 words x 32-bits, TX: 66 words x 32-bits)
- DMA, interrupts, or polling based data transfer supported

## High-Speed Quad SPI

Up to 66 MHz clock rates for very fast data transfers to and from SPI compatible devices.

Up to 256 Mbytes of memory mapped address space.

- Single data rate (SDR)
- Supports single, dual, and quad data modes
- Built-in direct mode and command sequencer mode
  - Direct mode: Access by use of transmission FIFO/reception FIFO (up to 16 word x 32 bit)
  - Command sequencer mode: Automatic access assigned to external device area.

## Clock and Reset

### ■ Clocks

Five clock sources (two external oscillators, two internal CR oscillators, and Main PLL) that are dynamically selectable.

- Main clock: 4 MHz to 48 MHz
- Sub clock: 32.768 kHz
- High-speed internal CR clock: 4 MHz
- Low-speed internal CR clock: 100 kHz
- Main PLL Clock

### ■ Resets

- Reset requests from INITX pin
- Power on reset
- Software reset
- Watchdog timer reset
- Low-voltage detector reset
- Clock supervisor reset

## Clock Supervisor (CSV)

Clocks generated by internal CR oscillators are used to supervise abnormality of the external clocks.

- External OSC clock failure (clock stop) is detected, reset is asserted.
- External OSC frequency anomaly is detected, interrupt or reset is asserted.

## Low-Voltage Detector (LVD)

This Series include two-stage monitoring of voltage on the VCC pins. When the voltage falls below the voltage that has been set, the low-voltage detector function generates an interrupt or reset.

- LVD1: error reporting via interrupt
- LVD2: auto-reset operation

## Low-power Consumption Mode

Six low power consumption modes are supported.

- Sleep
- Timer
- RTC
- Stop
- Deep standby RTC (selectable from with/without RAM retention)
- Deep standby stop (selectable from with/without RAM retention)

## Peripheral Clock Gating

The system can reduce the current consumption of the total system with gating the operation clocks of peripheral functions not used.

## **VBAT**

The consumption power during the RTC operation can be reduced by supplying the power supply independent from the RTC (calendar circuit)/32 kHz oscillation circuit. The following circuits can also be used.

- RTC
- 32-kHz oscillation circuit
- Power-on circuit
- Back up register: 32 bytes
- Port circuit

## **Debug**

- Serial wire JTAG debug port (SWJ-DP)
- Embedded trace macrocells (ETM) provide comprehensive debug and trace facilities.
- AHB trace macrocells (HTM)

## **Unique ID**

Unique value of the device (41-bit) is set.

## **Power Supply**

- Two power supplies
  - Wide range voltage: VCC = 2.7 V to 5.5 V
  - Power supply for VBAT: VBAT = 1.65 V to 5.5 V

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## 1. Product Lineup

### Memory Size

Product Name	S6E2C48H/J/L	S6E2C49H/J/L	S6E2C4AH/J/L
On-chip flash memory	1024 Kbytes	1536 Kbytes	2048 Kbytes
On-chip SRAM	128 Kbytes	192 Kbytes	256 Kbytes
	64 Kbytes	128 Kbytes	192 Kbytes
	32 Kbytes	32 Kbytes	32 Kbytes
	32 Kbytes	32 Kbytes	32 Kbytes

### Function

Product Name	S6E2C48H0A S6E2C49H0A S6E2C4AH0A	S6E2C48J0A S6E2C49J0A S6E2C4AJ0A	S6E2C48L0A S6E2C49L0A S6E2C4AL0A
Pin count	144	176/192	216
CPU	Freq.	Cortex-M4F, MPU, NVIC 128 ch 200 MHz	
Power supply voltage range		2.7V to 5.5V	
CAN		2 ch (Max)	
CAN-FD (non-ISO CAN-FD)		1 ch	
DMAC		8ch	
DSTC		256 ch	
External bus interface	Addr: 25-bit (Max), Data: 8-/16-bit CS: 9 (Max), SRAM, NOR flash NAND flash	Addr: 25-bit (Max), Data: 8-/16-bit CS: 9 (Max), SRAM, NOR flash , NAND flash SDRAM	Addr: 25-bit (Max), Data: 8-/16-/32-bit CS: 9 (Max), SRAM, NOR flash , NAND flash, SDRAM
Multi-function serial interface (UART/CSIO/LIN/I <sup>2</sup> C)		16ch (Max) ch 0 to ch 7 : FIFO, ch 8 to ch 15 : No FIFO	
Base timer (PWC/Reload timer/PWM/PPG)		16 ch (Max)	
MF timer	A/D activation compare	6 ch	3 units (Max)
	Input capture	4 ch	
	Free-run timer	3 ch	
	Output compare	6 ch	
	Waveform generator	3 ch	
	PPG	3 ch	
SD card interface		1 unit	
I <sup>2</sup> S	-	1 unit	
High-speed quad SPI	-	1 unit	
QPRC		4 ch (Max)	
Dual timer		1 unit	
Real-time clock		1 unit	
Watch counter		1 unit	
CRC accelerator		Yes (fixed, programmable)	
Watchdog timer		1 ch (SW) + 1 ch (HW)	
External interrupts		32 pins (Max)+ NMI × 1	
I/O ports	120 pins (Max)	152 pins (Max)	190 pins (Max)
12-bit A/D converter	24 ch (3 units)	32 ch (3 units)	
12-bit D/A converter		2 units (Max)	
CSV (clock supervisor)		Yes	
LVD (low-voltage detector)		2 ch	
Built-in CR	High-speed	4 MHz	
	Low-speed	100 kHz	

Product Name	S6E2C48H0A S6E2C49H0A S6E2C4AH0A	S6E2C48J0A S6E2C49J0A S6E2C4AJ0A	S6E2C48L0A S6E2C49L0A S6E2C4AL0A
Debug function	SWJ-DP/ETM/HTM		
Unique ID	Yes		

**Notes:**

- All signals of the peripheral function in each product cannot be allocated by limiting the pins of package.  
It is necessary to use the port relocate function of the I/O port according to your function use.
- See 12.4.3 Built-In CR Oscillation Characteristics for the accuracy of the built-in CR.

## 2. Packages

Package	Product Name	S6E2C48H0A S6E2C49H0A S6E2C4AH0A	S6E2C48J0A S6E2C49J0A S6E2C4AJ0A	S6E2C48L0A S6E2C49L0A S6E2C4AL0A
LQFP: LQS144 (0.5-mm pitch)		○	-	-
LQFP: LQP176 (0.5-mm pitch)		-	○	-
BGA : LBE192 (0.8-mm pitch)		-	○	-
LQFP: LQQ216 (0.4-mm pitch)		-	-	○

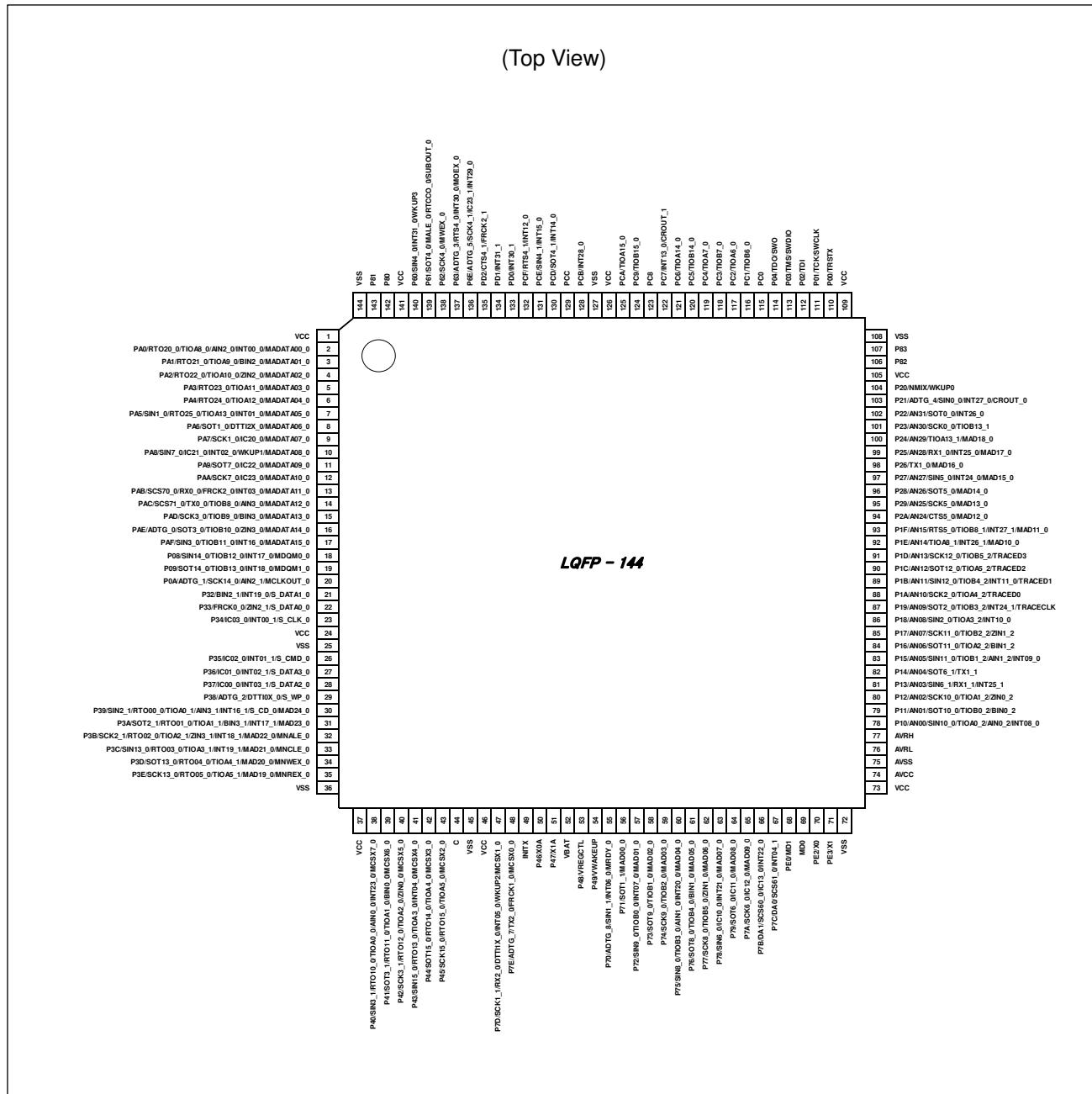
○: Supported

**Note:**

- See 14. Package Dimensions for detailed information on each package.

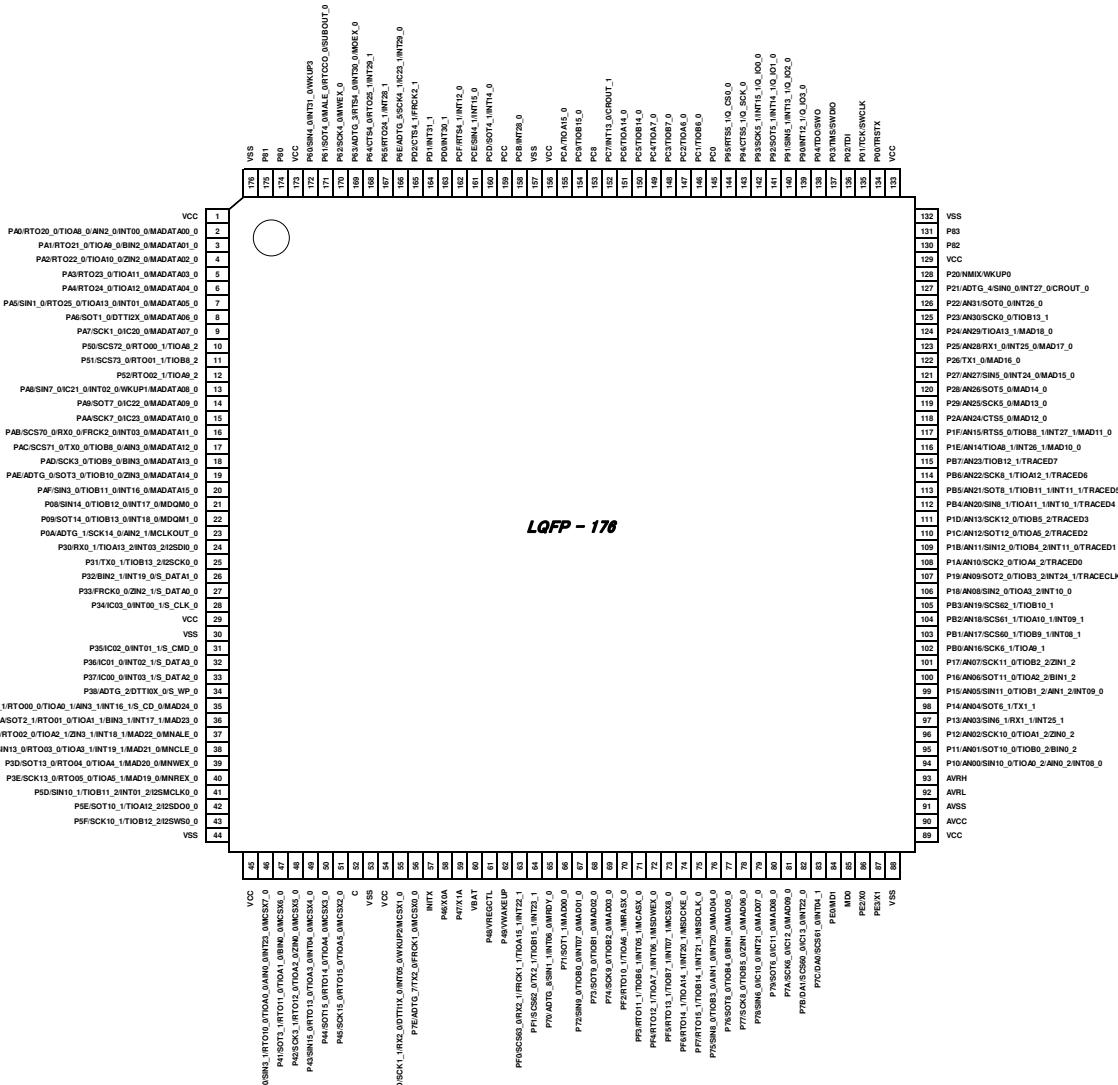
### 3. Pin Assignments

LQS144



#### Note:

- The number after the underscore ("\_) in pin names such as XXX\_1 and XXX\_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

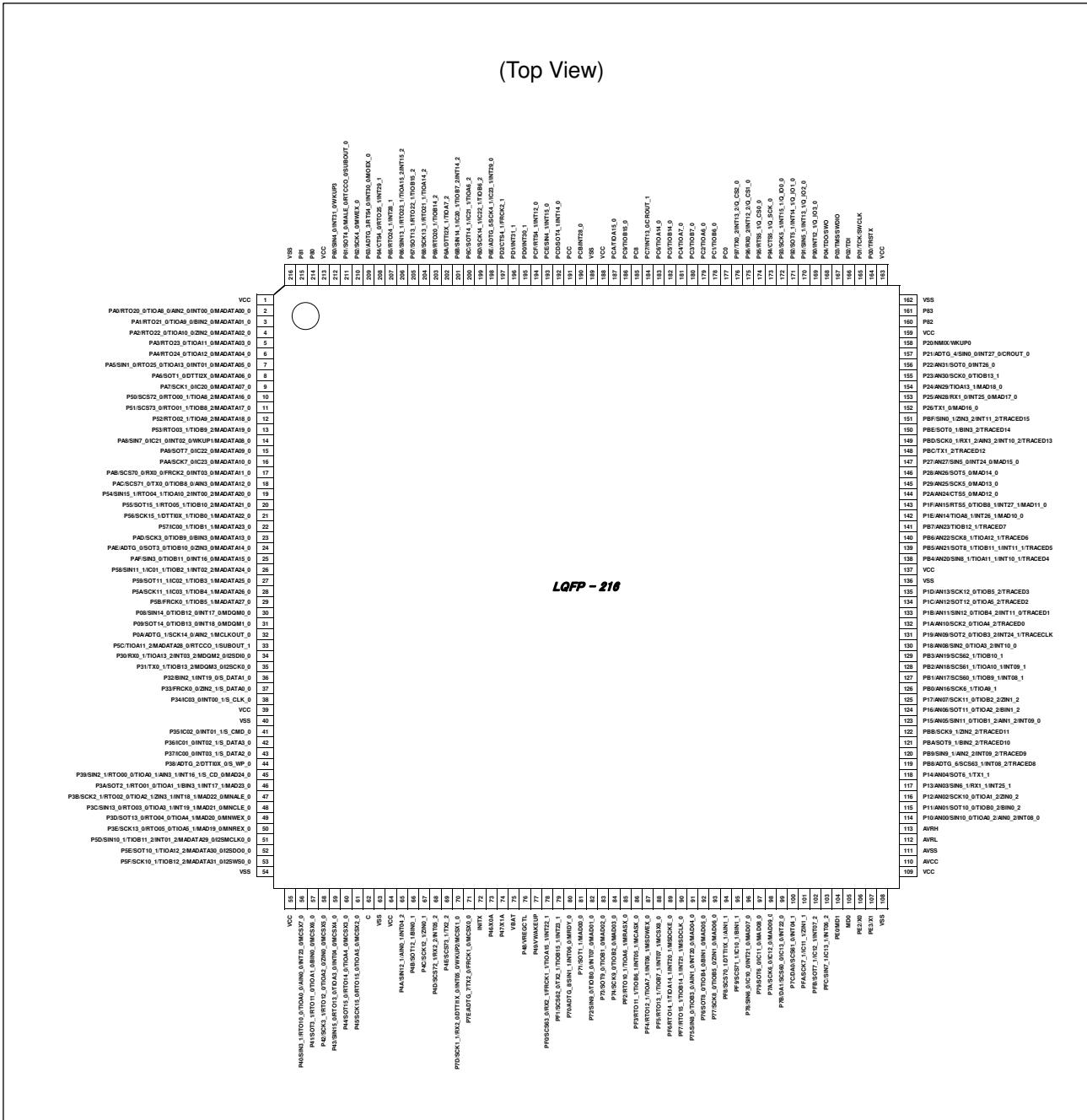
**LQP176**
**(Top View)**

**Note:**

- The number after the underscore ("\_) in pin names such as XXX\_1 and XXX\_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.



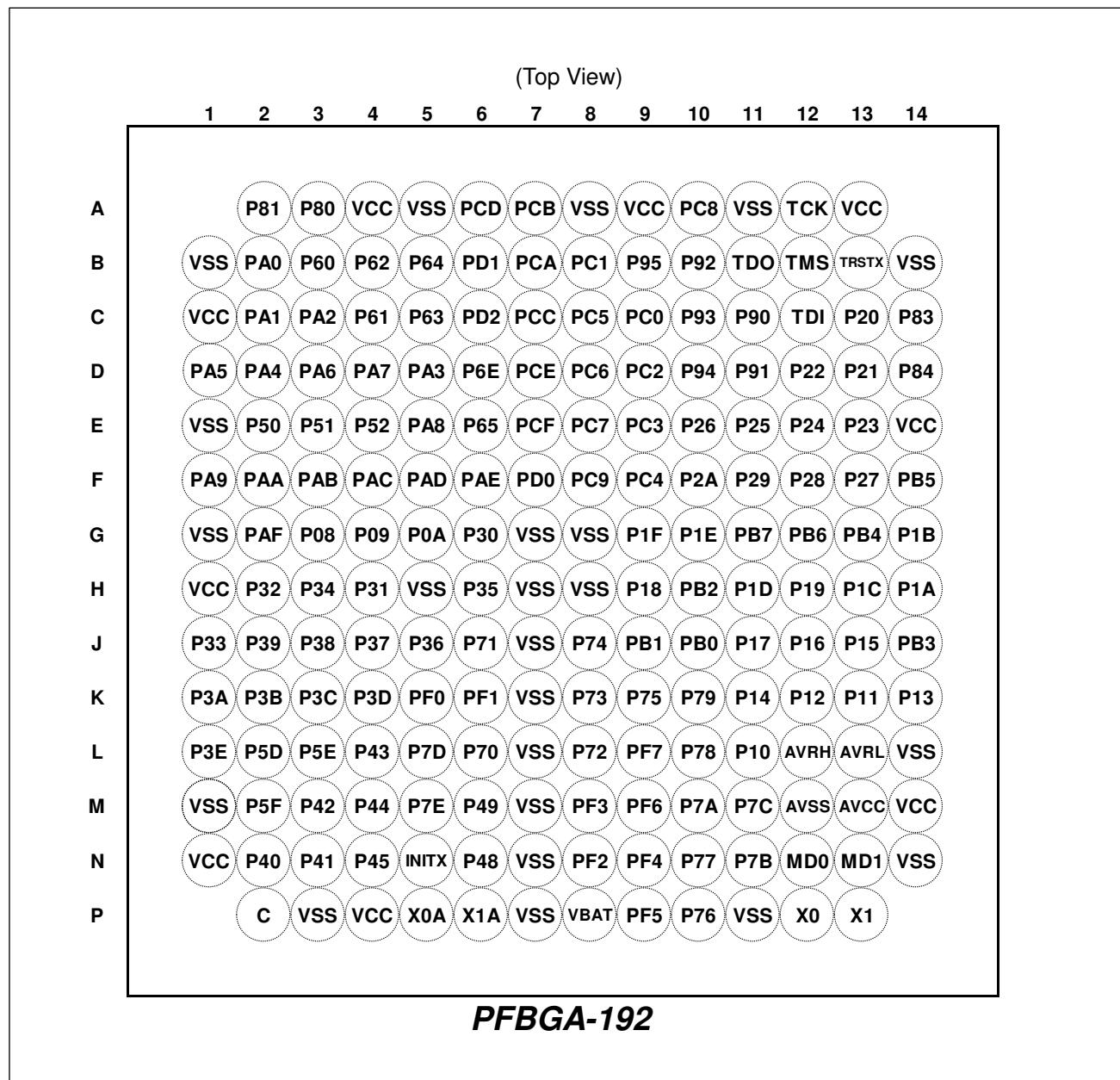
LQQ216

(Top View)



**Note:**

- The number after the underscore ("\_") in pin names such as XXX\_1 and XXX\_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

**LBE192**

**Note:**

- The number after the underscore ("\_") in pin names such as XXX\_1 and XXX\_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

## 4. Pin Descriptions

### List of Pin Functions

The number after the underscore ("\_") in pin names such as XXX\_1 and XXX\_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel.

Use the extended port function register (EPFR) to select the pin.

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
1	1	1	C1	VCC	-	-
2	2	2	B2	PA0		K
				RTO20_0 (PPG20_0)		
				TIOA8_0		
				AIN2_0		
				INT00_0		
				MADATA00_0		
				PA1		
3	3	3	C2	RTO21_0 (PPG20_0)	G	I
				TIOA9_0		
				BIN2_0		
				MADATA01_0		
				PA2		
4	4	4	C3	RTO22_0 (PPG22_0)	G	I
				TIOA10_0		
				ZIN2_0		
				MADATA02_0		
				PA3		
5	5	5	D5	RTO23_0 (PPG22_0)	G	I
				TIOA11_0		
				MADATA03_0		
				PA4		
6	6	6	D2	RTO24_0 (PPG24_0)	G	I
				TIOA12_0		
				MADATA04_0		
				PA5		
7	7	7	D1	SIN1_0	G	K
				RTO25_0 (PPG24_0)		
				TIOA13_0		
				INT01_0		
				MADATA05_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
8	8	8	D3	PA6	E	I
				SOT1_0 (SDA1_0))		
				DTT12X_0		
				MADATA06_0		
9	9	9	D4	PA7	E	I
				SCK1_0 (SCL1_0)		
				IC20_0		
				MADATA07_0		
10	10	-	E2	P50	E	I
				SCS72_0		
				RTO00_1 (PPG00_1)		
				TIOA8_2		
				MADATA16_0		
11	11	-	E3	P51	E	I
				SCS73_0		
				RTO01_1 (PPG00_1)		
				TIOB8_2		
				MADATA17_0		
12	12	-	E4	P52	E	I
				RTO02_1 (PPG02_1)		
				TIOA9_2		
				MADATA18_0		
13	-	-	-	P53	E	I
				RTO03_1 (PPG02_1)		
				TIOB9_2		
				MADATA19_0		
14	13	10	E5	PA8	I	Q
				SIN7_0		
				IC21_0		
				INT02_0		
				WKUP1		
				MADATA08_0		
15	14	11	F1	PA9	N	I
				SOT7_0 (SDA7_0)		
				IC22_0		
				MADATA09_0		
				PAA		
16	15	12	F2	SCK7_0 (SCL7_0)	N	I
				IC23_0		
				MADATA10_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
17	16	13	F3	PAB	E	K
				SCS70_0		
				RX0_0		
				FRCK2_0		
				INT03_0		
				MADATA11_0		
18	17	14	F4	PAC	E	I
				SCS71_0		
				TX0_0		
				TIOB8_0		
				AIN3_0		
				MADATA12_0		
19	-	-	-	P54	E	K
				SIN15_1		
				RTO04_1 (PPG04_1)		
				TIOA10_2		
				INT00_2		
				MADATA20_0		
20	-	-	-	P55	E	I
				SOT15_1 (SDA15_1)		
				RTO05_1 (PPG04_1)		
				TIOB10_2		
				MADATA21_0		
21	-	-	-	P56	E	I
				SCK15_1 (SCL15_1)		
				DTTI0X_1		
				TIOB0_1		
				MADATA22_0		
22	-	-	-	P57	E	I
				IC00_1		
				TIOB1_1		
				MADATA23_0		
23	18	15	F5	PAD	N	I
				SCK3_0 (SCL3_0)		
				TIOB9_0		
				BIN3_0		
				MADATA13_0		
24	19	16	F6	PAE	N	I
				ADTG_0		
				SOT3_0 (SDA3_0)		
				TIOB10_0		
				ZIN3_0		
				MADATA14_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
25	20	17	G2	PAF	I	K
				SIN3_0		
				TIOB11_0		
				INT16_0		
				MADATA15_0		
26	-	-	-	P58	E	K
				SIN11_1		
				IC01_1		
				TIOB2_1		
				INT02_2		
				MADATA24_0		
27	-	-	-	P59	E	I
				SOT11_1 (SDA11_1)		
				IC02_1		
				TIOB3_1		
				MADATA25_0		
28	-	-	-	P5A	E	I
				SCK11_1 (SCL11_1)		
				IC03_1		
				TIOB4_1		
				MADATA26_0		
29	-	-	-	P5B	E	I
				FRCK0_1		
				TIOB5_1		
				MADATA27_0		
				P08		
30	21	18	G3	SIN14_0	E	K
				TIOB12_0		
				INT17_0		
				MDQM0_0		
				P09		
31	22	19	G4	SOT14_0 (SDA14_0)	E	K
				TIOB13_0		
				INT18_0		
				MDQM1_0		
				P0A		
32	23	20	G5	ADTG_1	L	I
				SCK14_0 (SCL14_0)		
				AIN2_1		
				MCLKOUT_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
33	-	-	-	P5C TIOA11_2 MADATA28_0 RTCCO_1 SUBOUT_1	E	I
34	24	-	G6	P30 RX0_1 TIOA13_2 INT03_2 MDQM2_0 I2SDI0_0		K
35	25	-	H4	P31 TX0_1 TIOB13_2 MDQM3_0 I2SCK0_0		I
36	26	21	H2	P32 BIN2_1 INT19_0 S_DATA1_0	L	K
37	27	22	J1	P33 FRCK0_0 ZIN2_1 S_DATA0_0		I
38	28	23	H3	P34 IC03_0 INT00_1 S_CLK_0		K
39	29	24	H1	VCC		-
40	30	25	H5	VSS	L	-
41	31	26	H6	P35 IC02_0 INT01_1 S_CMD_0		K
42	32	27	J5	P36 IC01_0 INT02_1 S_DATA3_0		K
43	33	28	J4	P37 IC00_0 INT03_1 S_DATA2_0		K

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
44	34	29	J3	P38	E	I
				ADTG_2		
				DTTI0X_0		
				S_WP_0		
45	35	30	J2	P39	G	K
				SIN2_1		
				RTO00_0 (PPG00_0)		
				TIOA0_1		
				AIN3_1		
				INT16_1		
				S_CD_0		
				MAD24_0		
46	36	31	K1	P3A	G	K
				SOT2_1 (SDA2_1)		
				RTO01_0 (PPG00_0)		
				TIOA1_1		
				BIN3_1		
				INT17_1		
				MAD23_0		
				MNALE_0		
47	37	32	K2	P3B	G	K
				SCK2_1 (SCL2_1)		
				RTO02_0 (PPG02_0)		
				TIOA2_1		
				ZIN3_1		
				INT18_1		
				MAD22_0		
				MNACLE_0		
48	38	33	K3	P3C	G	K
				SIN13_0		
				RTO03_0 (PPG02_0)		
				TIOA3_1		
				INT19_1		
				MAD21_0		
				MNCLE_0		
				MNWEX_0		
49	39	34	K4	P3D	G	I
				SOT13_0 (SDA13_0)		
				RTO04_0 (PPG04_0)		
				TIOA4_1		
				MAD20_0		
				MNWEX_0		
				P3E		
				SCK13_0 (SCL13_0)		
50	40	35	L1	RTO05_0 (PPG04_0)	G	I
				TIOA5_1		
				MAD19_0		
				MNREX_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
51	41	-	L2	P5D	E	K
				SIN10_1		
				TIOB11_2		
				INT01_2		
				MADATA29_0		
				I2SMCLK0_0		
52	42	-	L3	P5E	E	I
				SOT10_1 (SDA10_1)		
				TIOA12_2		
				MADATA30_0		
				I2SDO0_0		
				P5F		
53	43	-	M2	SCK10_1 (SCL10_1)	E	I
				TIOB12_2		
				MADATA31_0		
				I2SWS0_0		
54	44	36	M1	VSS	-	-
55	45	37	N1	VCC	-	-
56	46	38	N2	P40	G	K
				SIN3_1		
				RTO10_0 (PPG10_0)		
				TIOA0_0		
				AIN0_0		
				INT23_0		
				MCSX7_0		
57	47	39	N3	P41	G	I
				SOT3_1 (SDA3_1)		
				RTO11_0 (PPG10_0)		
				TIOA1_0		
				BIN0_0		
				MCSX6_0		
				P42		
58	48	40	M3	SCK3_1 (SCL3_1)	G	I
				RTO12_0 (PPG12_0)		
				TIOA2_0		
				ZIN0_0		
				MCSX5_0		
				P43		
				SIN15_0		
59	49	41	L4	RTO13_0 (PPG12_0)	G	K
				TIOA3_0		
				INT04_0		
				MCSX4_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
60	50	42	M4	P44	G	I
				SOT15_0 (SDA15_0)		
				RTO14_0 (PPG14_0)		
				TIOA4_0		
				MCSX3_0		
61	51	43	N4	P45	G	I
				SCK15_0 (SCL15_0)		
				RTO15_0 (PPG14_0)		
				TIOA5_0		
				MCSX2_0		
62	52	44	P2	C	-	-
63	53	45	P3	VSS	-	-
64	54	46	P4	VCC	-	-
65	-	-	-	P4A	E	K
				SIN12_1		
				AIN0_1		
				INT04_2		
66	-	-	-	P4B	E	I
				SOT12_1 (SDA12_1)		
				BIN0_1		
67	-	-	-	P4C	E	I
				SCK12_1 (SCL12_1)		
				ZIN0_1		
68	-	-	-	P4D	E	K
				SCS72_1		
				RX2_2		
				INT05_2		
69	-	-	-	P4E	E	I
				SCS73_1		
				TX2_2		
70	55	47	L5	P7D	L	Q
				SCK1_1 (SCL1_1)		
				RX2_0		
				DTTI1X_0		
				INT05_0		
				WKUP2		
				MCSX1_0		
				P7E		
71	56	48	M5	ADTG_7	L	I
				TX2_0		
				FRCK1_0		
				MCSX0_0		
72	57	49	N5	INITX	B	C
73	58	50	P5	P46	P	S
				X0A		
74	59	51	P6	P47	Q	T
				X1A		
75	60	52	P8	VBAT	-	-
76	61	53	N6	P48	O	U
				VREGCTL		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
77	62	54	M6	P49	O	U
				VWAKEUP		
78	63	-	K5	PF0	E	K
				SCS63_0		
				RX2_1		
				FRCK1_1		
				TIOA15_1		
				INT22_1		
79	64	-	K6	PF1	E	K
				SCS62_0		
				TX2_1		
				TIOB15_1		
				INT23_1		
80	65	55	L6	P70	I	K
				ADTG_8		
				SIN1_1		
				INT06_0		
				MRDY_0		
81	66	56	J6	P71	E	I
				SOT1_1 (SDA1_1)		
				MAD00_0		
82	67	57	L8	P72	E	K
				SIN9_0		
				TIOB0_0		
				INT07_0		
				MAD01_0		
83	68	58	K8	P73	E	I
				SOT9_0 (SDA9_0)		
				TIOB1_0		
				MAD02_0		
				P74		
84	69	59	J8	SCK9_0 (SCL9_0)	E	I
				TIOB2_0		
				MAD03_0		
				PF2		
85	70	-	N8	RTO10_1 (PPG10_1)	L	I
				TIOA6_1		
				MRASX_0		
				PF3		
86	71	-	M8	RTO11_1 (PPG11_1)	L	K
				TIOB6_1		
				INT05_1		
				MCASX_0		
				PF4		
87	72	-	N9	RTO12_1 (PPG12_1)	L	K
				TIOA7_1		
				INT06_1		
				MSDWEX_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
88	73	-	P9	PF5	L	K
				RTO13_1 (PPG12_1)		
				TIOB7_1		
				INT07_1		
				MCSX8_0		
89	74	-	M9	PF6	L	K
				RTO14_1 (PPG14_1)		
				TIOA14_1		
				INT20_1		
				MSDCKE_0		
90	75	-	L9	PF7	L	K
				RTO15_1 (PPG14_1)		
				TIOB14_1		
				INT21_1		
				MSDCLK_0		
91	76	60	K9	P75	E	K
				SIN8_0		
				TIOB3_0		
				AIN1_0		
				INT20_0		
				MAD04_0		
92	77	61	P10	P76	E	I
				SOT8_0 (SDA8_0)		
				TIOB4_0		
				BIN1_0		
				MAD05_0		
93	78	62	N10	P77	E	I
				SCK8_0 (SCL8_0)		
				TIOB5_0		
				ZIN1_0		
				MAD06_0		
94	-	-	-	PF8	E	I
				SCS70_1		
				DTTI1X_1		
				AIN1_1		
95	-	-	-	PF9	E	I
				SCS71_1		
				IC10_1		
				BIN1_1		
96	79	63	L10	P78	E	K
				SIN6_0		
				IC10_0		
				INT21_0		
				MAD07_0		
97	80	64	K10	P79	L	I
				SOT6_0 (SDA6_0)		
				IC11_0		
				MAD08_0		

Pin No				Pin Name	I/O circuit type	Pin state type
LQQ216	LQP176	LQS144	LBE192			
98	81	65	M10	P7A	L	I
				SCK6_0 (SCL6_0)		
				IC12_0		
				MAD09_0		
99	82	66	N11	P7B	R	J
				DA1		
				SCS60_0		
				IC13_0		
				INT22_0		
100	83	67	M11	P7C	R	J
				DA0		
				SCS61_0		
				INT04_1		
101	-	-	-	PFA	E	I
				SCK7_1 (SCL7_1)		
				IC11_1		
				ZIN1_1		
102	-	-	-	PFB	E	K
				SOT7_1 (SDA7_1)		
				IC12_1		
				INT07_2		
103	-	-	-	PFC	E	K
				SIN7_1		
				IC13_1		
				INT06_2		
104	84	68	N13	PE0	C	E
				MD1		
105	85	69	N12	MD0	J	D
106	86	70	P12	PE2	A	A
				X0		
107	87	71	P13	PE3	A	B
				X1		
108	88	72	N14	VSS	-	-
109	89	73	M14	VCC	-	-
110	90	74	M13	AVCC	-	-
111	91	75	M12	AVSS	-	-
112	92	76	L13	AVRL	-	-
113	93	77	L12	AVRH	-	-
114	94	78	L11	P10	F	M
				AN00		
				SIN10_0		
				TIOA0_2		
				AIN0_2		
				INT08_0		